

BC151N

Order Code:

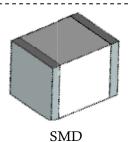
Version: A0

Gas Discharge Tube

Features

- Small Size Design EIA 1812 4.5×3.2×2.7mm
- Current Handling Capability 2,000A @ 8/20 μ s
- Low Capacitance and Insertion Loss
- Fast Response and Long Service Life
- Reliable to Protect Electrostatic Surge
- Moisture sensitivity level: Level 1

Exterior



Application information

Coaxial

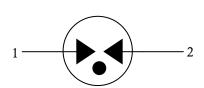
Schematic Symbol

Package (Top View)



Agency Approvals

Icon	Description		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
⊗	Mean lead free		
IR.	Compliance with UL497B, Certificated E232249		



Electrical Parameter

DC Breakdown Voltage 1)2)	100V/s	105-195	V
Impulse Sperk ever Veltage	At 1kV/µs	for 99 % of measured values ≤ 750	V
Impulse Spark-over Voltage	At 1kV/µs	Typical values of distribution ≤ 650	V
Impulse Discharge Current 3)	8/20µs	2,000	A
Arc Voltage	At 1A	~8	V
Insulation Resistance	DC=50V	≥1	GΩ
Capacitance at 1 MHz	VDC=0.5V	≤1.0	pF
Weight		~0.20	g
Operating And Storage Temperature		-40-90	$^{\circ}$
Marking		Without	

- 1) At delivery AQL 0.65 level II GB/T 2828.1-2003
- 2) In ionized mode3) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21



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Version: A0 2013-09-17

Part Numbering System

BC 151 N

(1) (2) (3)

- (1)Bencent Gas Discharge Tube
- (2) Series: DC Breakdown Voltage, e.g.: 151=15×10¹=150V
- (3) Tolerance of DC Breakdown Voltage, M=+-20%,

N=+-30%,the Specific tolerance is decided by the table of

Product Characteristics

Lead Material	Copper or iron nickel alloy
Body Material	Ceramics
Terminal Finish	100% Matte-Tin Plated

Environmental Reliability Characteristics

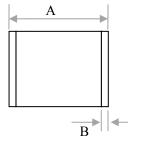
Testing items	Technical standards
High Temperature Storage Test Temperature: 85°C Time:2H	
Low Temperature Storage Test	Temperature: -40°C Time:2H
Vibration	Frequency: 10-500Hz Amplitude: 0.15mm Time: 45mins
Resistance of soldering heat	Temperature: 260±5°C Time of dip soldering: 10s, 1time

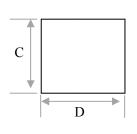
Note: Up-screen program can be specified by customer's request via contacting Bencent service

Solderability test

Solderability	Solder Pot Temperature:	245°C ±5°C
	Solder Dwell Time:	4-6 seconds

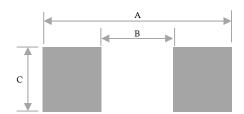
Product Dimensions





REF	mm inch	
A	4.5±0.3	0.177±0.012
В	0.5±0.2	0.020±0.008
С	2.7±0.2	0.106±0.008
D	3.2±0.2	0.126±0.008

Recommended Soldering Pad



REF	mm	inch
A	5.5	0.217
В	3.5	0.138
С	3.5	0.138

[&]quot;Electrical Parameter"

2013-09-17

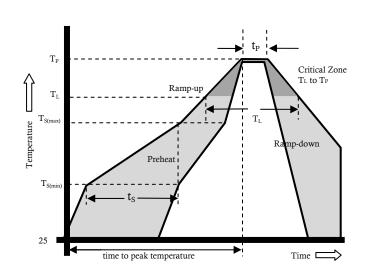
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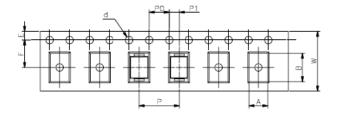
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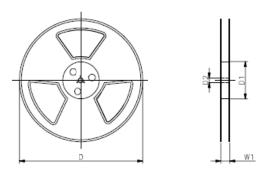
Reflow Profile

	Re	eflow Condition	Pb-Free assembly	
D.	Temperature Min		150°C	
Pre Heat	Те	mperature Max	200°C	
пеаі	Ti	me (min to max)	60 – 180 secs	
Average ramp up rate (Liquids) Tamp (T_L) to peal			3°C/second max	
T _S (max) t	T _S (max) to T _L - Ramp-up Rate		3°C/second max	
Reflow $-$ Temperature (T_L) $($ Liquids $)$		- Temperature (T _L) (Liquids)	217°C	
	- Temperature (T _L)		60 – 150 seconds	
Peak Tem	Peak Temperature (T _P)		260+0/-5 °C	
Time within 5°C of actual peak Temperature (tp)		•	8 – 20 seconds	
Ramp-down Rate		Rate	6°C/second max	
Time 25°C to peak Temperature (T _P)		peak Temperature (T _P)	8 minutes Max.	
Do not exceed		d	260°C	



Package Reel Information





REF	mm	inch		
A	3.7±0.2 0.146±0.008			
В	4.7±0.2	0.185±0.008		
d	Ф1.5±0.1	Ф 0.059±0. 004		
E	1.75±0.1	0.069±0.004		
F	5.5±0.1	0.217±0.002		
P	8.0±0.1 0.315±0.004			
P0	4.0±0.1 0.157±0.004			
P1	2.0±0.1 0.079±0.004			
W	12.0±0.2	0.472±0.008		
D	Ф330.0	Ф13.0		
D1	Φ50Min	Φ1.97Min		
D2	Φ13±0.15	0.512±0.006		
W1	16.8±2.0	0.661±0.079		

OUTLINE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)	CARTON SIZE(mm)		
				L	W	Н
TAPING	2,000	32,000	330	360	360	380